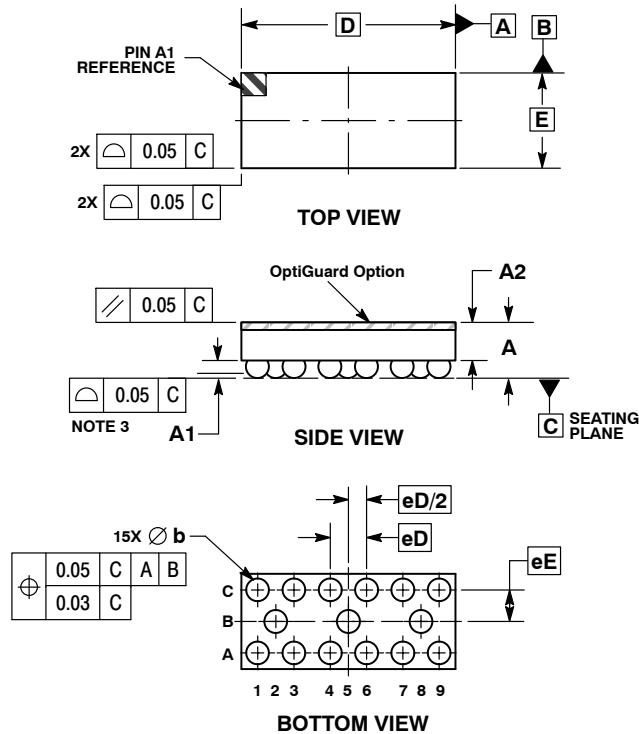




SCALE 4:1

WLCSP15, 2.36x1.05
CASE 567BP
ISSUE O

DATE 26 JUL 2010

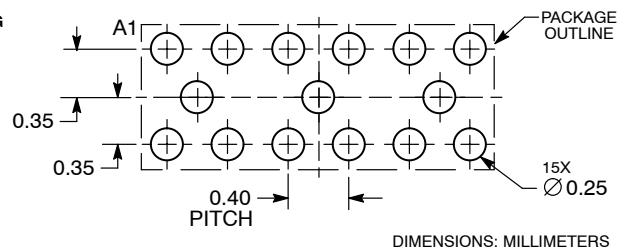


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

| DIM | MILLIMETERS | |
|-----|-------------|------|
| | MIN | MAX |
| A | 0.57 | 0.72 |
| A1 | 0.17 | 0.24 |
| A2 | 0.42 | REF |
| b | 0.24 | 0.29 |
| D | 2.36 | BSC |
| E | 1.05 | BSC |
| eD | 0.400 | BSC |
| eE | 0.347 | BSC |

RECOMMENDED
SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

| | | |
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| DESCRIPTION: | WLCSP15, 2.36X1.05 | PAGE 1 OF 1 |

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